

CLAIMS

1. A spiral antenna comprising:
 - an antenna substrate having a first surface and a second surface;
 - two or more spiral conductors disposed on the first surface of the antenna substrate, each of the spiral antennas having a first end which defines an inner radius of the spiral and a second end which defines an outer radius of the spiral;
 - a feed circuit substrate disposed over the second surface of the antenna substrate;
 - a feed circuit disposed in or on said feed circuit substrate;
 - a vertical launch feed line having a first end coupled to the first end of each spiral conductor and a second end coupled to the feed circuit; and
 - a vertical launch feed line Faraday wall surrounding the vertical launch feed line.
2. The spiral antenna of claim 1, wherein the feed circuit substrate includes a first ground plane and a second ground plane.
3. The spiral antenna of claim 2, wherein the vertical launch feed line Faraday wall has a cylindrical shape disposed between the first ground plane of the feed circuit substrate and the first surface of the antenna substrate.
4. The spiral antenna of claim 3, wherein the feed circuit includes two feed lines, a first end of a first spiral conductor of the two or more spiral conductors being coupled to a first feed line and a first end of a second spiral conductor of the two or more spiral conductors being coupled to a second feed line.
5. The spiral antenna of claim 4, wherein the feed circuit Faraday wall surrounds the two feed lines.
6. The spiral antenna of claim 3, further comprising a feed circuit Faraday wall disposed between the first and second ground planes of said feed circuit substrate and the around the feed circuit.

7. The spiral antenna of claim 2, further comprising a feed circuit Faraday wall disposed between the first and second ground planes of the feed circuit substrate and around the feed circuit.
8. A spiral antenna comprising:
an antenna substrate having a first surface and a second surface;
two or more spiral conductors disposed on the first surface of the antenna substrate, each of the spiral antennas having a first end which defines an inner radius of the spiral and a second end which defines an outer radius of the spiral;
a feed circuit substrate disposed over the second surface of the antenna substrate, the feed circuit substrate having a first ground plane and a second ground plane;
a feed circuit disposed in or on said feed circuit substrate; and
a feed circuit Faraday wall disposed between the first and second ground planes of said feed circuit substrate and the around the feed circuit.
9. The spiral antenna of claim 8, further comprising a vertical launch feed line having a first end coupled to the first end of each spiral conductor and a second end coupled to the feed circuit.
10. The spiral antenna of claim 9, further comprising a vertical launch feed line Faraday wall surrounding the vertical launch feed line.
11. The spiral antenna of claim 10, wherein the vertical launch feed line Faraday wall has a cylindrical shape disposed between the first ground plane of the feed circuit substrate and the first surface of the antenna substrate.
12. The spiral antenna of claim 11, wherein the feed circuit includes two feed lines, a first end of a first spiral conductor of the two or more spiral conductors being coupled to a first feed line and a first end of a second spiral conductor of the two or more spiral conductors being coupled to a second feed line.

13. The spiral antenna of claim 12, wherein the feed circuit Faraday wall surrounds the two feed lines.
14. An AMT processing for fabricating a spiral antenna comprises:
- (a) removing conductive material from an antenna substrate to form two or more conductive spirals on the substrate;
 - (b) at a first end of each spiral conductor, forming an opening in the substrate which extends from a first surface to a second opposing surface of the substrate;
 - (c) forming an opening which surrounds each of the openings which terminate at a first end of the spiral, said opening having a cylindrical shape; and
 - (d) filling each of the opening with a conductive ink so as to form conductive signal paths and conductive walls in the antenna substrate.
15. The method of claim 14, wherein removing conductive material, forming an opening in the substrate, and/or forming an opening which surrounds each of the openings includes a milling technique.
16. The method of claim 14, further comprising forming a conductive vertical launch that is coupled to the spiral antenna and the signal paths.
17. A method of forming a conductive vertical launch that is coupled to a spiral antenna and a feed circuit, the method comprising:
- pre-tinning a bottom trace of a feed circuit with a solder bump after a signal trace has been milled out of a double cladded dielectric substrate;
 - drilling a hole in a top layer of the feed circuit and bonding film to allow room for the solder bump to reflow in a cavity during bonding;
 - pre-cutting a cavity leading to the top layer with a spiral and laminating the assembly together;
 - inserting or filling the hole with copper until the copper touches the solder bump; and

pressing a top of the copper with a soldering iron to reflow the solder at the feed circuit.